Low V_{CE(sat)} NPN Transistors, 60 V, 1 A

NSS60101DMR6

ON Semiconductor's e^2 PowerEdge family of low $V_{CE(sat)}$ transistors are miniature surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and LED lightning, power management...etc. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_A = 25°C)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	60	Vdc
Collector-Base Voltage	V _{CBO}	80	Vdc
Emitter-Base Voltage	V _{EBO}	6	Vdc
Collector Current – Continuous	Ic	1	Α
Collector Current - Peak	I _{CM}	2	Α

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance Junction-to-Ambient (Notes 1 and 2)	$R_{\theta JA}$	234	°C/W
Total Power Dissipation per Package @ T _A = 25°C (Note 2)	P _D	0.53	W
Thermal Resistance Junction-to-Ambient (Note 3)	$R_{\theta JA}$	300	°C/W
Power Dissipation per Transistor @ T _A = 25°C (Note 3)	P _D	0.40	W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

- 1. Per JESD51-7 with 100 mm² pad area and 2 oz. Cu (Dual Operation).
- 2. P_D per Transistor when both are turned on is one half of Total P_D or 0.53 Watts.
- 3. Per JESD51-7 with 100 mm² pad area and 2 oz. Cu (Single-Operation).



ON Semiconductor®

www.onsemi.com

60 Volt, 1 Amp NPN Low $V_{CE(sat)}$ Transistors



SC-74 CASE 318F



MARKING

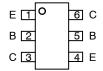
RAD = Specific Device Code

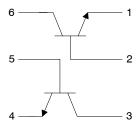
M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS





ORDERING INFORMATION

Device	Package	Shipping [†]	
NSS60101DMR6T1G			
NSS60101DMR6T2G	SC-74	3000/Tape & Reel	
NSV60101DMR6T1G	(Pb-Free)		
NSV60101DMR6T2G			

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

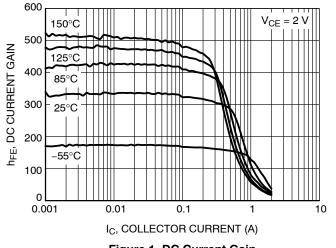
Table 1. ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage (I _C = 10 mA, I _B = 0)	V _{(BR)CEO}	60			V
Collector-Base Breakdown Voltage (Ic = 0.1 mA, I _E = 0)	V _{(BR)CBO}	80			V
Emitter-Base Breakdown Voltage (I _E = 0.1 mA, I _C = 0)	V _{(BR)EBO}	6			V
Collector Cutoff Current (V _{CB} = 60 V, I _E = 0)	I _{CBO}			100	nA
Emitter Cutoff Current (V _{BE} = 5.0 V)	I _{EBO}			100	nA
ON CHARACTERISTICS			•	•	•
DC Current Gain (Note 4) $ (I_C = 100 \text{ mA}, V_{CE} = 2 \text{ V}) $ $ (I_C = 500 \text{ mA}, V_{CE} = 2 \text{ V}) $ $ (I_C = 1 \text{ A}, V_{CE} = 2 \text{ V}) $ $ (I_C = 1 \text{ mA}, V_{CE} = 5 \text{ V}) $ $ (I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}) $ $ (I_C = 500 \text{ mA}, V_{CE} = 5 \text{ V}) $ $ (I_C = 1 \text{ A}, V_{CE} = 5 \text{ V}) $ $ (I_C = 1 \text{ A}, V_{CE} = 5 \text{ V}) $	h _{FE}	200 150 70 250 250 200	320 290 110 335 335 310 295		
Collector–Emitter Saturation Voltage (Note 4) $ (I_C = 100 \text{ mA}, I_B = 1 \text{ mA}) $ $ (I_C = 500 \text{ mA}, I_B = 50 \text{ mA}) $ $ (I_C = 1 \text{ A}, I_B = 50 \text{ mA}) $ $ (I_C = 1 \text{ A}, I_B = 100 \text{ mA}) $	V _{CE(sat)}		0.080 0.078 0.170 0.143	0.200 0.150 0.250 0.200	V
Base – Emitter Saturation Voltage (Note 4) $ (I_C = 500 \text{ mA}, I_B = 50 \text{ mA}) $ $ (I_C = 1 \text{ A}, I_B = 50 \text{ mA}) $ $ (I_C = 1 \text{ A}, I_B = 100 \text{ mA}) $	V _{BE(sat)}		0.87 0.91 0.94	1.50 1.50 1.60	V
Base-Emitter Turn-on Voltage (Note 4) $(I_C = 1 \text{ mA}, V_{CE} = 1 \text{ V})$ $(I_C = 500 \text{ mA}, V_{CE} = 2 \text{ V})$	V _{BE(on)}	0.27	0.57 0.76	0.90	V
DYNAMIC CHARACTERISTICS			•	•	
Input Capacitance (V _{EB} = 1 V, f = 1.0 MHz)	C _{ibo}		100		pF
Output Capacitance (V _{CB} = 10 V, f = 1.0 MHz)	C _{obo}		8.0		pF
Cutoff Frequency ($I_C = 50 \text{ mA}$, $V_{CE} = 2.0 \text{ V}$, $f = 100 \text{ MHz}$)	f _T		200		MHz
SWITCHING TIMES	-		•	•	
Delay Time ($V_{CC} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, I_{B1} = 25 \text{ mA}, I_{B2} = -25 \text{ mA}$)	t _d		10		ns
ON Time (V_{CC} = 10 V, I_{C} = 0.5 A, I_{B1} = 25 mA, I_{B2} = -25 mA)	t _{on}		28		ns
Rise Time (V_{CC} = 10 V, I_{C} = 0.5 A, I_{B1} = 25 mA, I_{B2} = -25 mA)	t _r		18		ns
Storage Time (V_{CC} = 10 V, I_{C} = 0.5 A, I_{B1} = 25 mA, I_{B2} = -25 mA)	t _s		622		ns
OFF Time (V_{CC} = 10 V, I_{C} = 0.5 A, I_{B1} = 25 mA, I_{B2} = -25 mA)	t _{off}		709		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Condition: Pulse Width = $300 \mu sec$, Duty Cycle $\leq 2\%$.

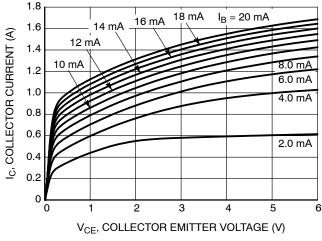
TYPICAL CHARACTERISTICS



600 $V_{CE} = 5 V$ 150°C 500 h_{FE}, DC CURRENT GAIN 125°C 400 85°C 300 25°C 200 -55°C 100 0 0.001 0.01 0.1 10 IC, COLLECTOR CURRENT (A)

Figure 1. DC Current Gain

Figure 2. DC Current Gain



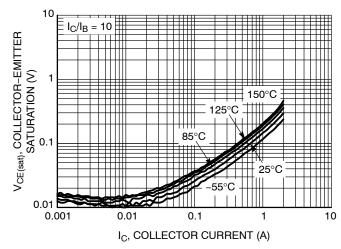
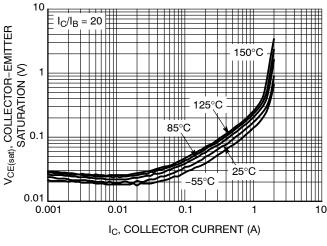


Figure 3. Collector Current as a Function of Collector Emitter Voltage

Figure 4. Collector-Emitter Saturation Voltage



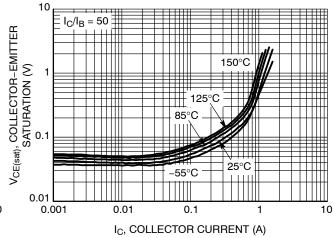


Figure 5. Collector-Emitter Saturation Voltage

Figure 6. Collector-Emitter Saturation Voltage

TYPICAL CHARACTERISTICS

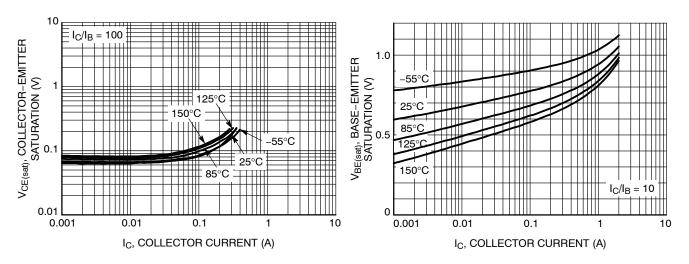


Figure 7. Collector-Emitter Saturation Voltage

Figure 8. Base-Emitter Saturation Voltage

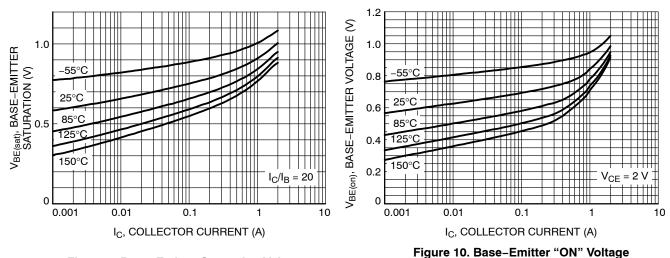
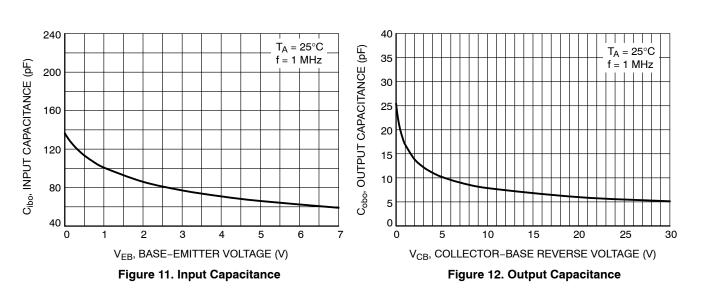


Figure 9. Base-Emitter Saturation Voltage



TYPICAL CHARACTERISTICS

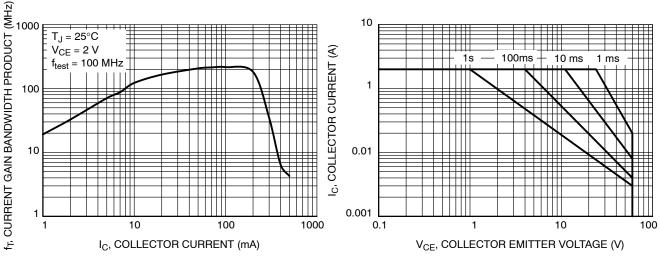


Figure 13. f_T, Current Gain Bandwidth Product

Figure 16. Safe Operating Area $(T_A = 25^{\circ}C)$

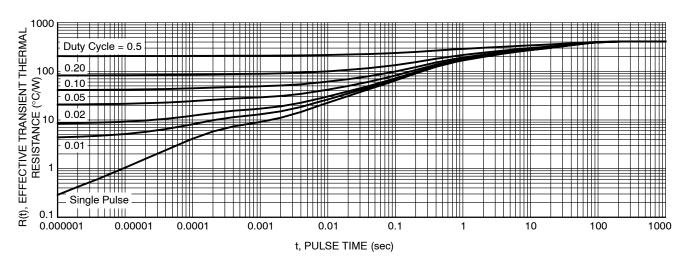


Figure 14. Thermal Resistance by Transistor

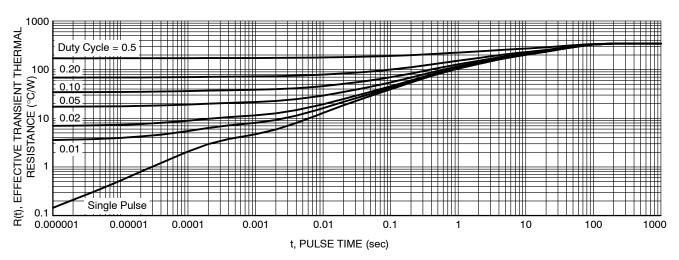
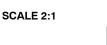


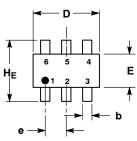
Figure 15. Thermal Resistance for Both Transistors

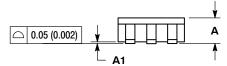


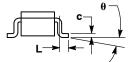
SC-74 CASE 318F-05 ISSUE N

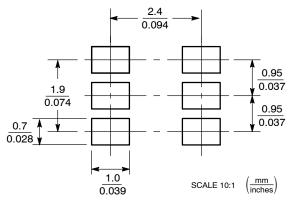
DATE 08 JUN 2012











SOLDERING FOOTPRINT*

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH
- CONTROLLING DIMENSION: INCH.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
 THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. 318F-01, -02, -03, -04 OBSOLETE. NEW STANDARD 318F-05.

	MILLIMETERS		INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.90	1.00	1.10	0.035	0.039	0.043
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.25	0.37	0.50	0.010	0.015	0.020
С	0.10	0.18	0.26	0.004	0.007	0.010
D	2.90	3.00	3.10	0.114	0.118	0.122
E	1.30	1.50	1.70	0.051	0.059	0.067
е	0.985	0.95	11.05	0.084	0.037	0.10241
L	0.20	0.40	0.60	0.008	0.016	0.024
HE	2.50	2.75	3.00	0.099	0.108	0.118
θ		_			_	

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code M

may or may not be present.

= Pb-Free Package (Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■",

STYLE 1: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. ANODE 6. CATHODE	2. COLLECTOR 3. EMITTER 4. NO CONNECTION 5. COLLECTOR	STYLE 3: PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2 5. BASE 2 6. COLLECTOR 1	STYLE 4: PIN 1. COLLECTOR 2 2. EMITTER 1/EMITTER 2 3. COLLECTOR 1 4. EMITTER 3 5. BASE 1/BASE 2/COLLECTOR 3 6. BASE 3	STYLE 5: PIN 1. CHANNEL 1 2. ANODE 3. CHANNEL 2 4. CHANNEL 3 5. CATHODE 6. CHANNEL 4	STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. ANODE	PIN 1. NO CONNECTION 2. COLLECTOR 3. EMITTER 4. NO CONNECTION 5. COLLECTOR	PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2 5. BASE 2	PIN 1. COLLECTOR 2 2. EMITTER 1/EMITTER 2 3. COLLECTOR 1 4. EMITTER 3 5. BASE 1/BASE 2/COLLECTOR 3	PIN 1. CHANNEL 1 2. ANODE 3. CHANNEL 2 4. CHANNEL 3 5. CATHODE	PIN 1. CATHOD 2. ANODE 3. CATHOD 4. CATHOD 5. CATHOD

3. CATHODE 4. CATHODE 5. ANODE 6. CATHODE	3. EMITTER 4. NO CONNECTION 5. COLLECTOR 6. BASE	3. COLLECTOR 2 4. EMITTER 2 5. BASE 2 6. COLLECTOR 1	3. COLLECTOR 1 4. EMITTER 3 5. BASE 1/BASE 2/COLLECTOR 3 6. BASE 3	3. CHANNEL 2 4. CHANNEL 3 5. CATHODE 6. CHANNEL 4
STYLE 7: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1	STYLE 8: PIN 1. EMITTER 1 2. BASE 2 3. COLLECTOR 2 4. EMITTER 2 5. BASE 1 6. COLLECTOR 1	STYLE 9: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 10: PIN 1. ANODE/CATHODE 2. BASE 3. EMITTER 4. COLLECTOR 5. ANODE 6. CATHODE	STYLE 11: PIN 1. EMITTER 2. BASE 3. ANODE/CATHODE 4. ANODE 5. CATHODE 6. COLLECTOR

DOCUMENT NUMBER:	98ASB42973B	Electronic versions are uncontrolled except when accessed directly from the Document Reposit Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	SC-74		PAGE 1 OF 1

ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

 \Diamond